

Product data sheet

1. General description

Enhanced ultrafast power diode in a SOD113 (2-lead TO-220F) plastic package.

2. Features and benefits

- High thermal cycling performance
- Isolated package
- Low thermal resistance
- Soft recovery characteristic
- Low on-state losses

3. Applications

- Dual Mode (DCM and CCM) PFC
- Power Factor Correction (PFC) for Interleaved Topology

4. Quick reference data

Symbol	Parameter	Conditions	Values				Unit
Absolute	maximum rating						
V _{RRM}	repetitive peak reverse voltage		600			V	
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _h ≤ 97 °C; Fig. 1; Fig. 2	5			A	
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _h ≤ 97 °C; square-wave pulse	10			А	
I_{FSM}	non-repetitive peak forward current	t _p = 10 ms; T _{j(init)} = 25 °C; sine-wave pulse; <u>Fig. 3</u>	60 66			A	
		$t_{\rm p}$ = 8.3 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse;			А		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics	· · · · · ·				-	
V _F	forward voltage	I _F = 5 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.3	1.9	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.1	1.7	V
Dynamic	characteristics						
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s};$ $T_i = 25 \text{ °C}; \text{ Fig. 6}$		-	17.5	35	ns

5. Pinning information

Table	2.	Pinning	information
	_		Internation

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	
2	А	anode		к_Ң_А
mb	n.c.	mounting base; isolated	C C C C C C C C C C C C C C C C C C C	001aaa020

6. Ordering information

Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
BYV25FX-600	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 2-lead TO-220 "full pack"	SOD113		

7. Marking

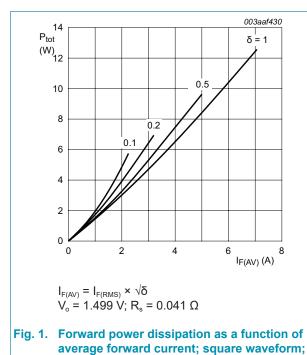
Table 4. Marking codes	
Type number	Marking codes
BYV25FX-600	BYV25FX-600

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V _{RWM}	crest working reverse voltage		600	V
V _R	reverse voltage	DC	600	V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _h ≤ 97 °C; Fig. 1; Fig. 2	5	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _h ≤ 97 °C; square-wave pulse	10	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse;	60	А
	forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse;	66	А
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		150	°C



maximum values

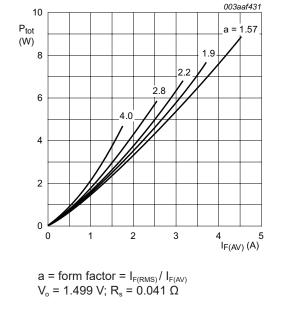
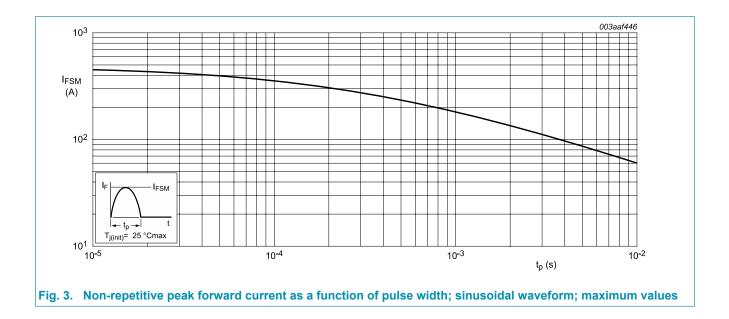
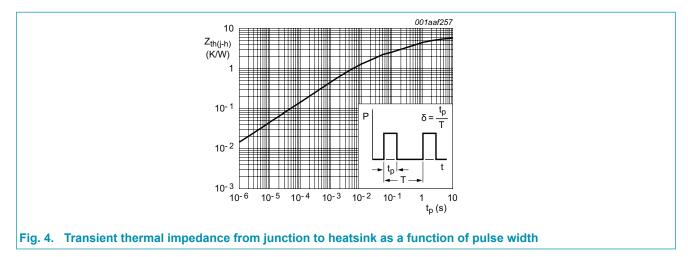


Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values



9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-h)}}$	thermal resistance from junction to heatsink	with heatsink compound; Fig 4	-	-	5.5	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	-	55	-	K/W

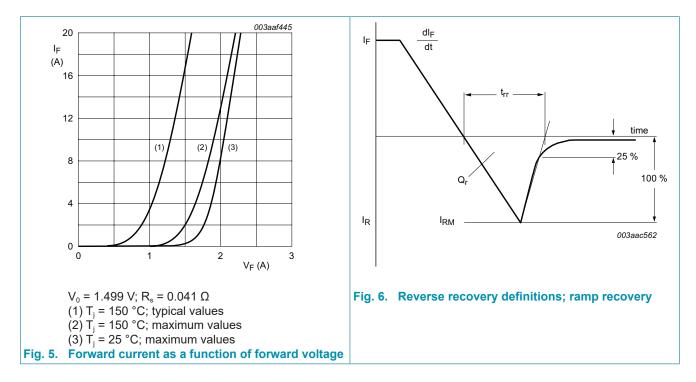


10. Isolation characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{\text{isol}(\text{RMS})}$	RMS isolation voltage	50 Hz \leq f \leq 60 Hz; RH \leq 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	f = 1 MHz; from cathode to external heatsink	-	10	-	pF

11. Characteristics

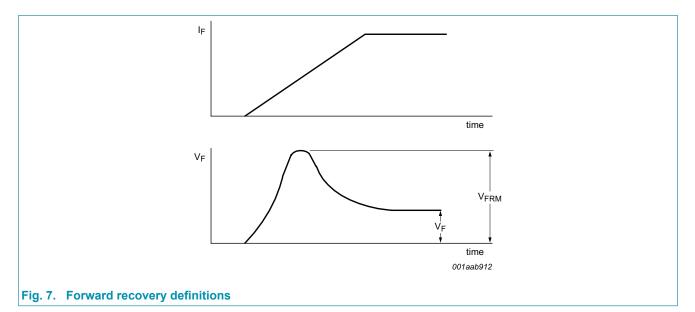
Table 8. Cl	haracteristics						
Symbol	Parameter	Conditions	IV	lin	Тур	Max	Unit
Static cha	aracteristics						
V_{F}	forward voltage	I _F = 5 A; T _j = 25 °C; <u>Fig. 4</u>	-		1.3	1.9	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 4</u>	-		1.1	1.7	V
I _R	reverse current	V _R = 600 V; T _j = 100 °C	-		-	1.5	mA
		V _R = 600 V; T _j = 25 °C	-		-	50	μA
Dynamic	characteristics						
Q _r	recovered charge	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}_F/\text{d}t = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \frac{\text{Fig. 6}}{0.000}$	-		13	-	nC
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/μs; T _j = 25 °C; <u>Fig. 6</u>	-		17.5	35	ns
I _{RM}	peak reverse recovery current	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}_F/\text{d}t = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \frac{\text{Fig. 6}}{0.000}$	-		1.5	-	A
V_{FR}	forward recovery voltage	I _F = 1 A; dI _F /dt = 100 A/μs; T _j = 25 °C; <u>Fig. 6</u>	-		3.2	-	V



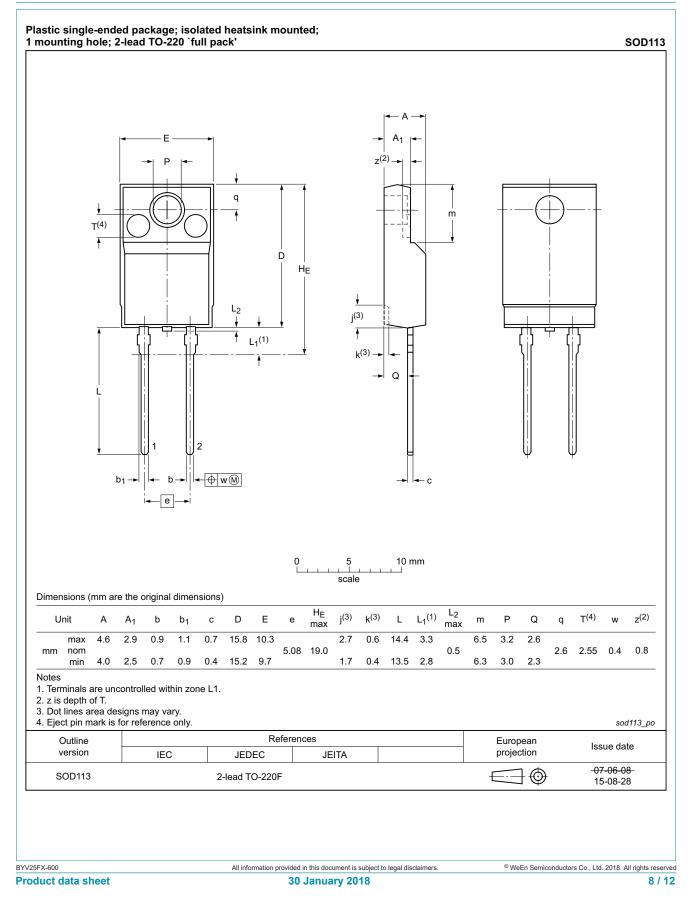
WeEn Semiconductors

BYV25FX-600

Enhanced ultrafast power diode



12. Package outline



13. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
BYV25FX-600 v.3	20180130	Product data sheet	-	BYV25FX-600 v.2		
Modifications:	Change from NXP version to WeEn version					
BYV25FX-600 v.2	20110307	Product data sheet	-	BYV25FX-600 v.1		
Modifications:	Various changes to content.	·				
BYV25FX-600 v.1	20101004	Product data sheet	-	-		

BYV25FX-600

Enhanced ultrafast power diode

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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